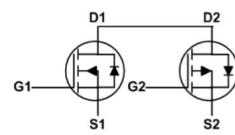


**• General Description**

The ZMC88305D combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ . It combine one N Channel MOSFET and one P channel MOSFET.

**• Product Summary**

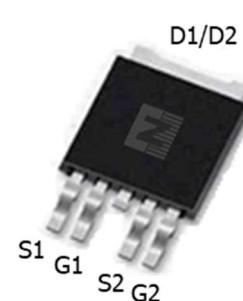
$V_{DS1} = 30V$   
 $V_{DS2} = -30V$   
 $R_{DS(ON)1} = 22m\Omega$   
 $R_{DS(ON)2} = 39m\Omega$   
 $I_{D1} = 25A$   
 $I_{D2} = -20A$

**• Features**

- Advance high cell density Trench technology
- Low  $R_{DS(ON)}$  to minimize conductive loss
- Low Gate Charge for fast switching
- Dual DIE in one package

**• Application**

- Power Management in Notebook Computer
- BLDC Motor driver



TO-252-4

**• Ordering Information:**

Part NO.	ZMC88305D
Marking	ZMC88305
Packing Information	REEL TAPE
Basic ordering unit (pcs)	2500

**• N Channel Absolute Maximum Ratings ( $T_c = 25^\circ C$ )**

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$I_D @ T_c = 25^\circ C$	25	A
	$I_D @ T_c = 75^\circ C$	19	A
	$I_D @ T_c = 100^\circ C$	15	A
Pulsed Drain Current <sup>①</sup>	$I_{DM}$	50	A
Total Power Dissipation( $T_c = 25^\circ C$ )	$P_D @ T_c = 25^\circ C$	50	W
Total Power Dissipation( $T_A = 25^\circ C$ )	$P_D @ T_A = 25^\circ C$	2.0	W
Operating Junction Temperature	$T_J$	-55 to 150	$^\circ C$
Storage Temperature	$T_{STG}$	-55 to 150	$^\circ C$
Single Pulse Avalanche Energy	$E_{AS}$	6	mJ


**•P Channel Absolute Maximum Ratings (T<sub>c</sub>=25°C)**

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V <sub>DS</sub>	-30	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current	I <sub>D</sub> @TC=25°C	-20	A
	I <sub>D</sub> @TC=75°C	-15	A
	I <sub>D</sub> @TC=100°C	-12.6	A
Pulsed Drain Current <sup>①</sup>	I <sub>DM</sub>	-40	A
Total Power Dissipation(TC=25°C)	P <sub>D</sub> @TC=25°C	50	W
Total Power Dissipation(TA=25°C)	P <sub>D</sub> @TA=25°C	2	W
Operating Junction Temperature	T <sub>J</sub>	-55 to 150	°C
Storage Temperature	T <sub>STG</sub>	-55 to 150	°C
Single Pulse Avalanche Energy	E <sub>AS</sub>	35	mJ

**•Thermal resistance**

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal resistance, junction - case	R <sub>thJC</sub>	-	-	2.3	° C/W
Thermal resistance, junction - ambient	R <sub>thJA</sub>	-	-	62	° C/W
Soldering temperature, wavesoldering for 10s	T <sub>sold</sub>	-	-	265	° C

**•N Channel Electronic Characteristics**

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	30			V
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	1.2	1.6	2.5	V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V			1.0	uA
Gate- Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V ,V <sub>DS</sub> =0V			±100	nA
Static Drain-source On Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =6A		22	29	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =4A		30	40	mΩ
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =25V, I <sub>D</sub> =5A		2		s


**•Electronic Characteristics**

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> =25V f = 1MHz	-	300	-	pF
Output capacitance	C <sub>oss</sub>		-	55	-	
Reverse transfer capacitance	C <sub>rss</sub>		-	50	-	

**•Gate Charge characteristics(T<sub>a</sub> = 25°C)**

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Total gate charge	Q <sub>g</sub>	V <sub>DD</sub> = 15V I <sub>D</sub> = 6A V <sub>GS</sub> = 10V	-	6	-	nC
Gate - Source charge	Q <sub>gs</sub>		-	1	-	
Gate - Drain charge	Q <sub>gd</sub>		-	1.5	-	

**•P Channel Electronic Characteristics**

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250uA	-30			V
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = -250uA	-1.2		-2.5	V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =-30V, V <sub>GS</sub> = 0V			-1.0	uA
Gate- Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V ,V <sub>DS</sub> = 0V			±100	nA
Static Drain-source On Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-6A		39	50	mΩ
		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-4A		55	70	mΩ
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =-10V, I <sub>D</sub> =-5A		1.5		s

**•Electronic Characteristics**

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> =-25V f = 1MHz	-	430	-	pF
Output capacitance	C <sub>oss</sub>		-	140	-	
Reverse transfer capacitance	C <sub>rss</sub>		-	90	-	

**•Gate Charge characteristics(T<sub>a</sub> = 25°C)**

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Total gate charge	Q <sub>g</sub>	V <sub>DD</sub> = -15V I <sub>D</sub> = -6A V <sub>GS</sub> = -10V	-	11	-	nC
Gate - Source charge	Q <sub>gs</sub>		-	2.0	-	
Gate - Drain charge	Q <sub>gd</sub>		-	2.9	-	

**•N Channel characteristics curve**

Fig.1 Power Dissipation

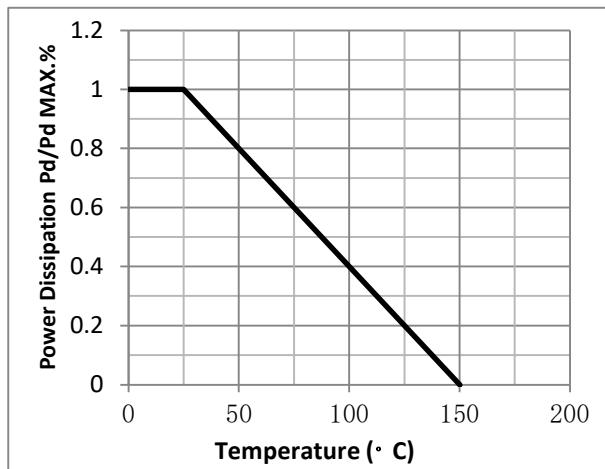


Fig.2 Typical output Characteristics

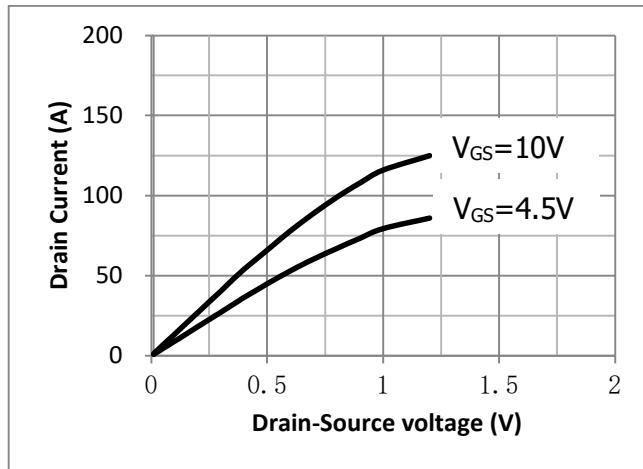


Fig.3 Threshold Voltage V.S Junction Temperature

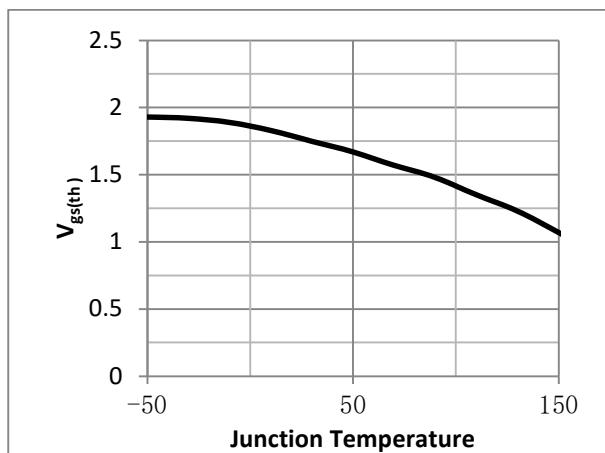


Fig.4 Resistance V.S Drain Current

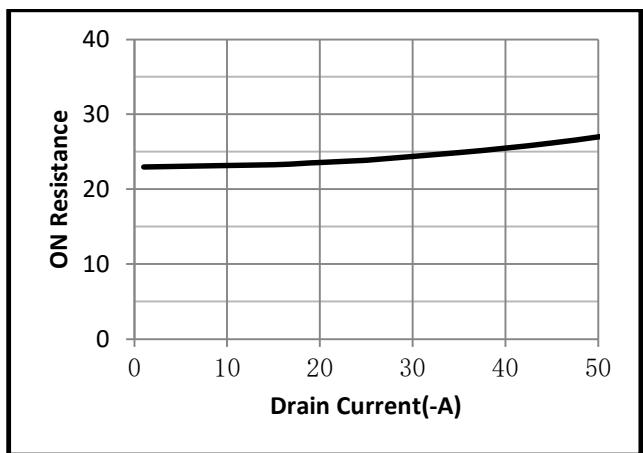


Fig.5 On-Resistance VS Gate Source Voltage

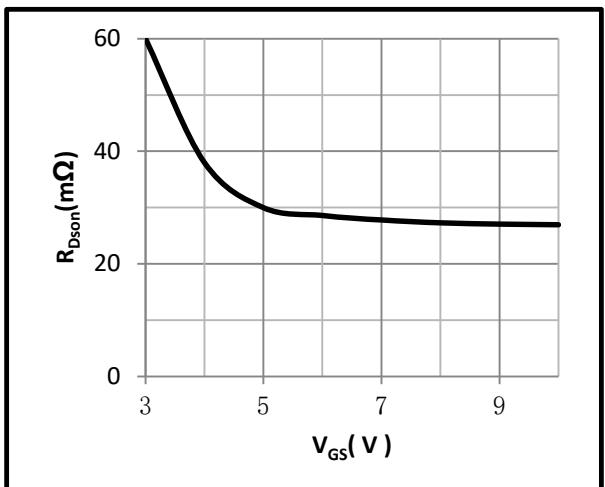
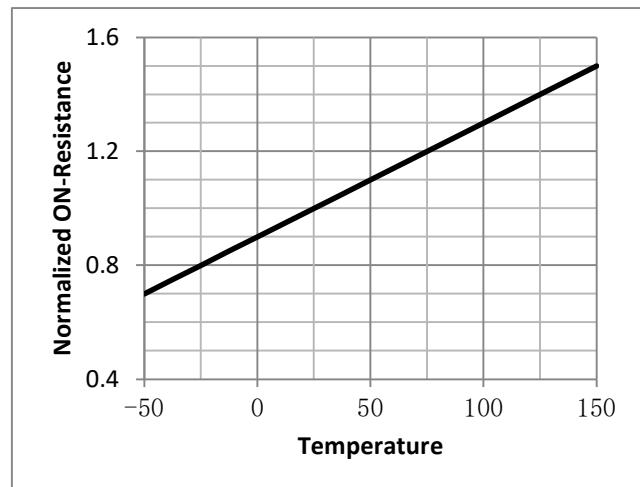


Fig.6 On-Resistance V.S Junction Temperature



**•P Channel characteristics curve**

Fig.1 Power Dissipation Derating Curve

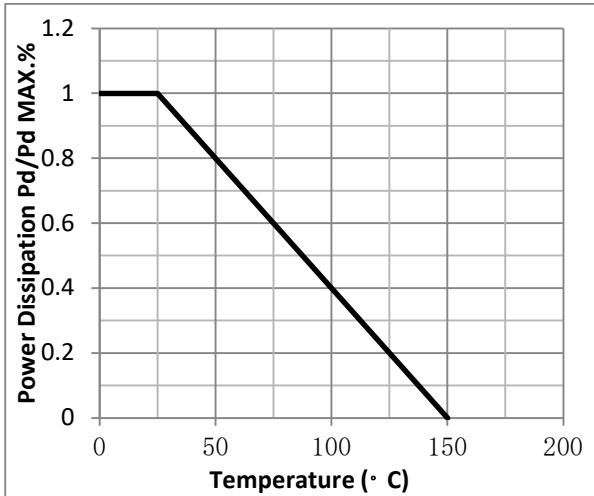


Fig.2 Typical output Characteristics

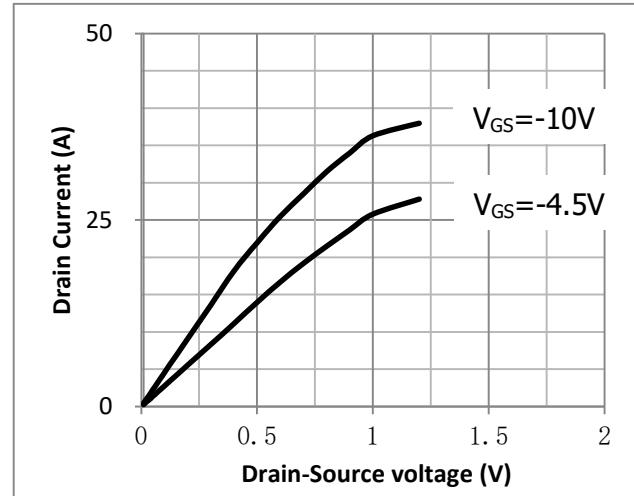


Fig.3 Threshold Voltage V.S Junction Temperature

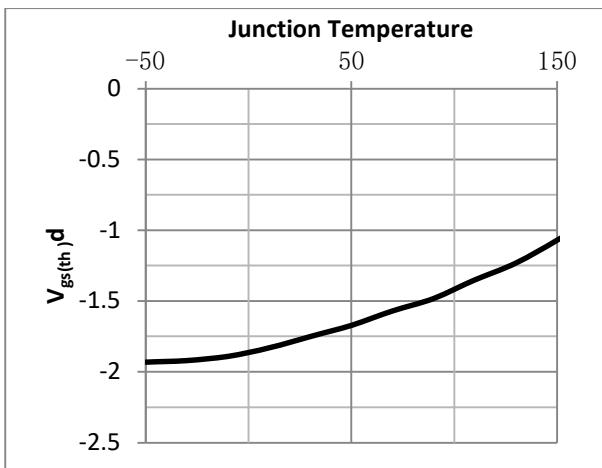


Fig.4 Resistance V.S Drain Current

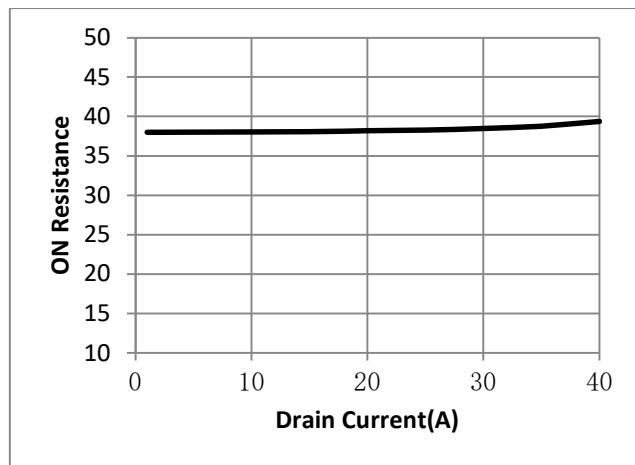


Fig.5 On-Resistance VS Gate Source Voltage

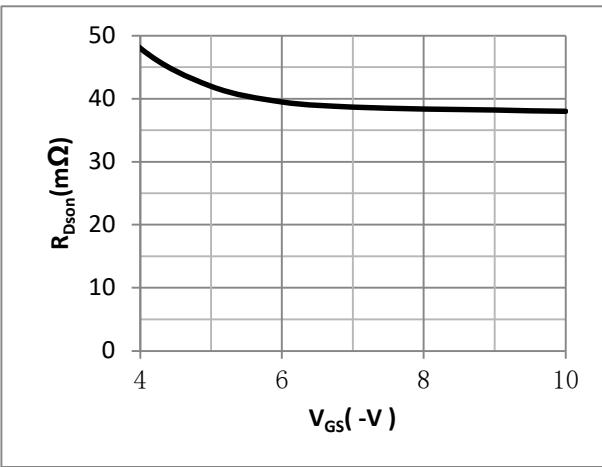
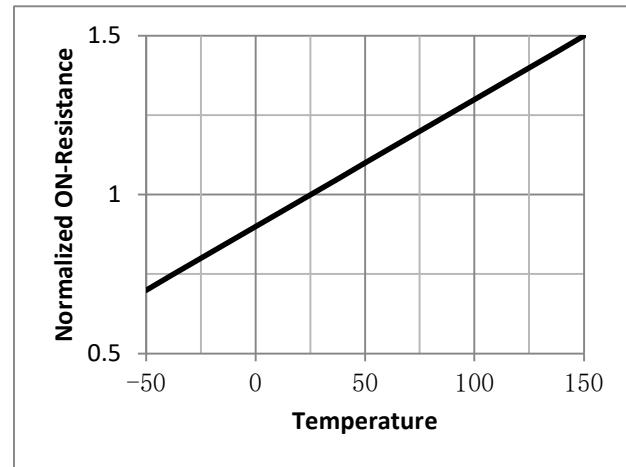


Fig.6 On-Resistance V.S Junction Temperature



**•Test Circuit**

Fig.1 Gate Charge Measurement Circuit

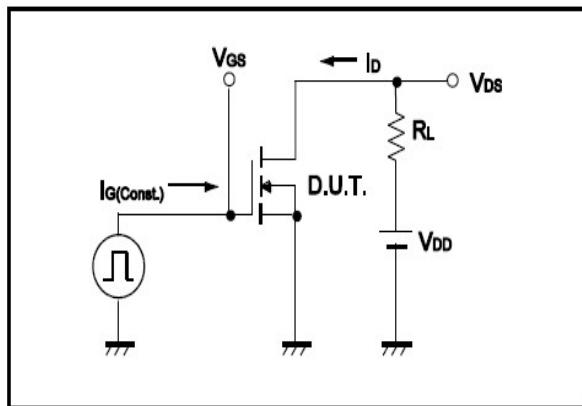


Fig.2 Gate Charge Waveform

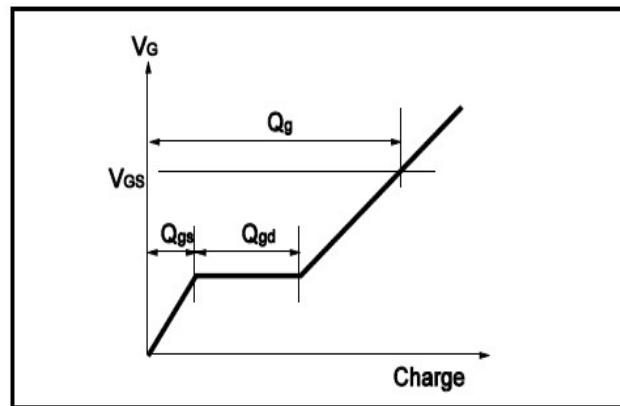


Fig.3 Switching Time Measurement Circuit

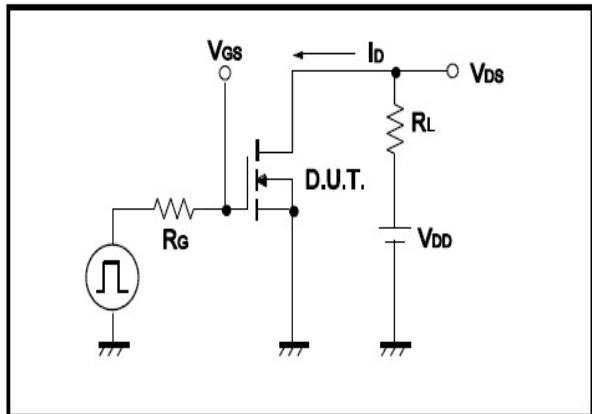


Fig.4 Switching Time Waveform

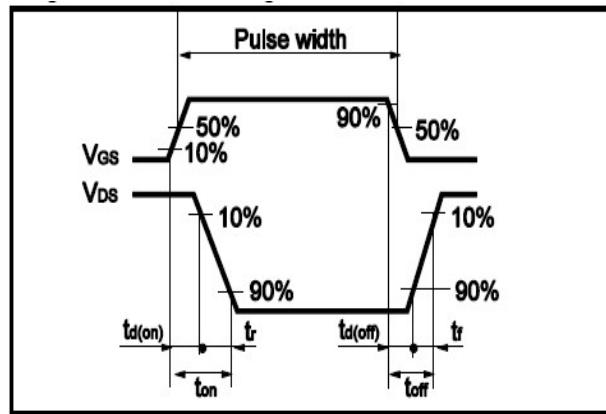


Fig.5 Avalanche Measurement Circuit

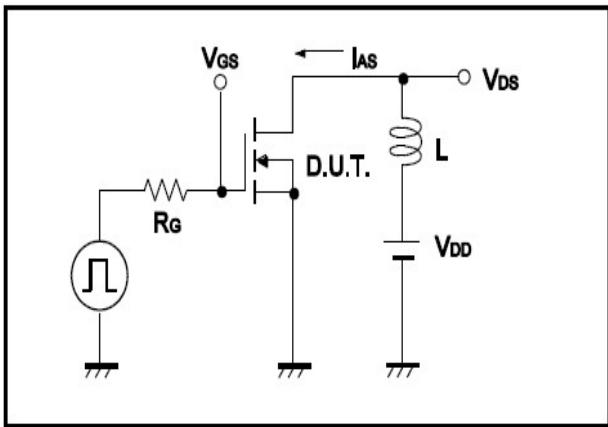
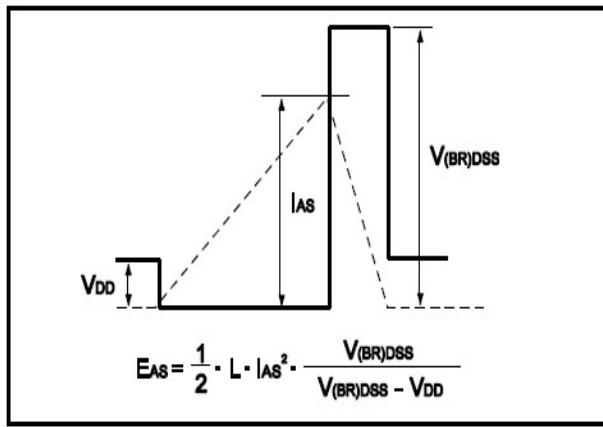


Fig.6 Avalanche Waveform



## •Dimensions(TO-252-4)

Unit: mm

